



STS5PF20V

P-CHANNEL 20V - 0.065Ω - 5A SO-8
2.5V-DRIVE STripFET™ II POWER MOSFET

| TYPE | V _{DSS} | R _{DS(on)} | I _D |
|-----------|------------------|---------------------------------------|----------------|
| STS5PF20V | 20 V | < 0.080 Ω (@4.5V) < 0.10 Ω (@2.5V) | 5 A |

- TYPICAL R_{DS(on)} = 0.065Ω (@4.5V)
- TYPICAL R_{DS(on)} = 0.085Ω (@2.5V)
- ULTRA LOW THRESHOLD GATE DRIVE (2.5V)
- STANDARD OUTLINE FOR EASY AUTOMATED SURFACE MOUNT ASSEMBLY



SO-8

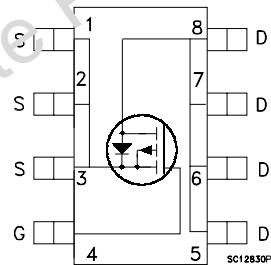
DESCRIPTION

This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely extremely low on-resistance when driven at 2.5V.

APPLICATIONS

- POWER MANAGEMENT IN CELLULAR PHONES
- DC-DC CONVERTERS
- BATTERY MANAGEMENT IN NOMADIC EQUIPMENT

INTERNAL SCHEMATIC DIAGRAM



ORDER CODES

| PART NUMBER | MARKING | PACKAGE | PACKAGING |
|-------------|---------|---------|-------------|
| STS5PF20V | S5PF20V | SO-8 | TAPE & REEL |

STS5PF20V

ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|--------------------|---|---------|------|
| V_{DS} | Drain-source Voltage ($V_{GS} = 0$) | 20 | V |
| V_{DGR} | Drain-gate Voltage ($R_{GS} = 20 \text{ k}\Omega$) | 20 | V |
| V_{GS} | Gate- source Voltage | ± 8 | V |
| I_D | Drain Current (continuous) at $T_C = 25^\circ\text{C}$ | 5 | A |
| I_D | Drain Current (continuous) at $T_C = 100^\circ\text{C}$ | 3.1 | A |
| $I_{DM} (\bullet)$ | Drain Current (pulsed) | 20 | A |
| P_{TOT} | Total Dissipation at $T_C = 25^\circ\text{C}$ | 2.5 | W |

(•) Pulse width limited by safe operating area

Note: For the P-CHANNEL MOSFET actual polarity of voltages and current has to be reversed

THERMAL DATA

| | | | |
|---------------|---|------------|------|
| $R_{thj-amb}$ | Thermal Resistance Junction-ambient Max | 50 | °C/W |
| T_j | Max. Operating Junction Temperature | -55 to 150 | °C |
| T_{stg} | Storage Temperature | -55 to 150 | °C |

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE SPECIFIED)

OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------|--|---|------|------|-----------|--------------------------------|
| $V_{(BR)DSS}$ | Drain-source Breakdown Voltage | $I_D = 250 \mu\text{A}, V_{GS} = 0$ | 20 | | | V |
| I_{DSS} | Zero Gate Voltage Drain Current ($V_{GS} = 0$) | $V_{DS} = \text{Max Rating}$ $V_{DS} = \text{Max Rating}, T_C = 125^\circ\text{C}$ | | | 1 10 | μA μA |
| I_{GSS} | Gate-body Leakage Current ($V_{DS} = 0$) | $V_{GS} = \pm 8\text{V}$ | | | ± 100 | nA |

ON (1)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------------|-----------------------------------|--|------|----------------|---------------|----------------------|
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$ | 0.45 | | | V |
| $R_{DS(on)}$ | Static Drain-source On Resistance | $V_{GS} = 4.5\text{V}, I_D = 2.5 \text{ A}$ $V_{GS} = 2.5\text{V}, I_D = 2.5 \text{ A}$ | | 0.065 0.085 | 0.080 0.10 | Ω Ω |

DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-------------|------------------------------|--|------|------|------|------|
| $g_{fs}(1)$ | Forward Transconductance | $V_{DS} = 15 \text{ V}, I_D = 2.5 \text{ A}$ | | 6.6 | | S |
| C_{iss} | Input Capacitance | $V_{DS} = 15 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0$ | | 412 | | pF |
| C_{oss} | Output Capacitance | | | 179 | | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 42.5 | | pF |

ELECTRICAL CHARACTERISTICS (CONTINUED)**SWITCHING ON**

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------|--------------------|---|-------------|-------------|-------------|-------------|
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DD} = 10 \text{ V}$, $I_D = 2.5 \text{ A}$ $R_G = 4.7\Omega$ $V_{GS} = 2.5 \text{ V}$ (see test circuit, Figure 1) | | 11 | | ns |
| t_r | Rise Time | | | 47 | | ns |
| Q_g | Total Gate Charge | $V_{DD} = 10 \text{ V}$, $I_D = 5 \text{ A}$, | | 4.5 | 6 | nC |
| Q_{gs} | Gate-Source Charge | $V_{GS} = 2.5\text{V}$ | | 0.73 | | nC |
| Q_{gd} | Gate-Drain Charge | (see test circuit, Figure 2) | | 1.75 | | nC |

SWITCHING OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------|---------------------|--|-------------|-------------|-------------|-------------|
| $t_{d(off)}$ | Turn-off-Delay Time | $V_{DD} = 10 \text{ V}$, $I_D = 2.5 \text{ A}$, | | 39 | | ns |
| t_f | Fall Time | $R_G = 4.7\Omega$, $V_{GS} = 2.5 \text{ V}$ (see test circuit, Figure 1) | | 20 | | ns |

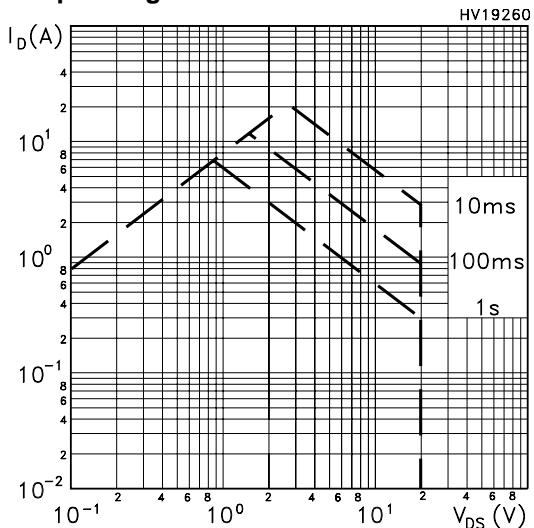
SOURCE DRAIN DIODE

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------|-------------------------------|--|-------------|-------------|-------------|-------------|
| I_{SD} | Source-drain Current | | | | 5 | A |
| I_{SDM} | Source-drain Current (pulsed) | | | | 20 | A |
| $V_{SD}(1)$ | Forward On Voltage | $I_{SD} = 5 \text{ A}$, $V_{GS} = 0$ | | | 1.2 | V |
| t_{rr} | Reverse Recovery Time | $I_{SD} = 5 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$, | | 32 | | ns |
| Q_{rr} | Reverse Recovery Charge | $V_{DD} = 16 \text{ V}$, $T_j = 150^\circ\text{C}$ | | 12.8 | | nC |
| I_{RRM} | Reverse Recovery Current | (see test circuit, Figure 3) | | 0.8 | | A |

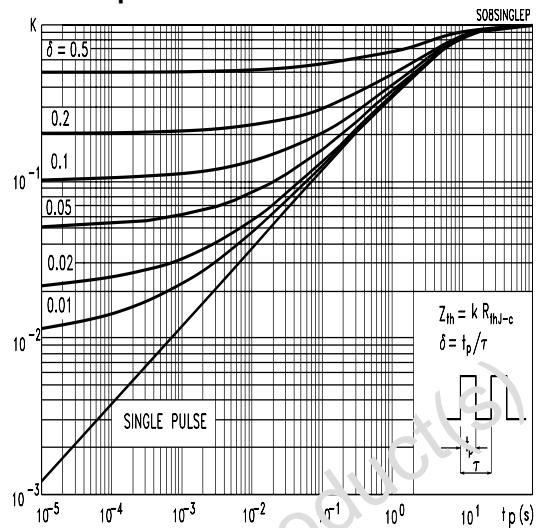
Note: 1. Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %.

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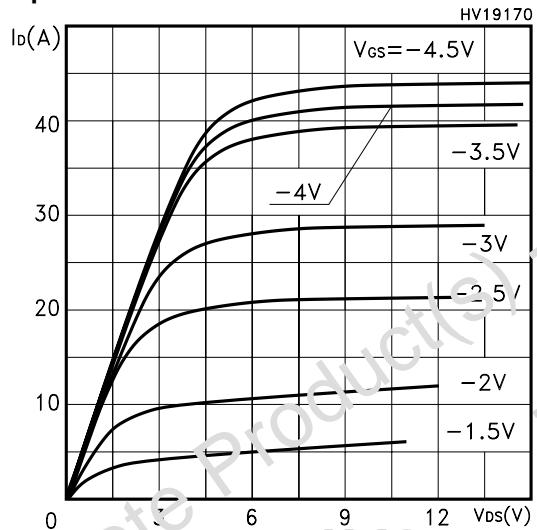
Safe Operating Area



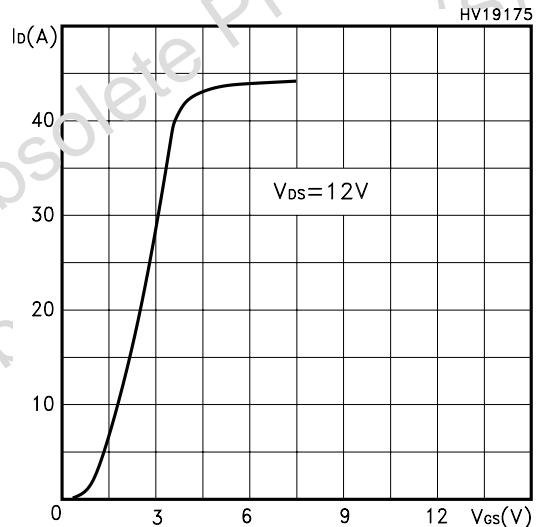
Thermal Impedance



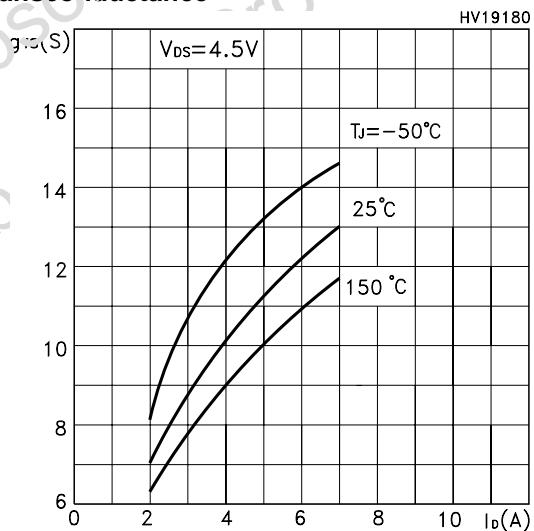
Output Characteristics



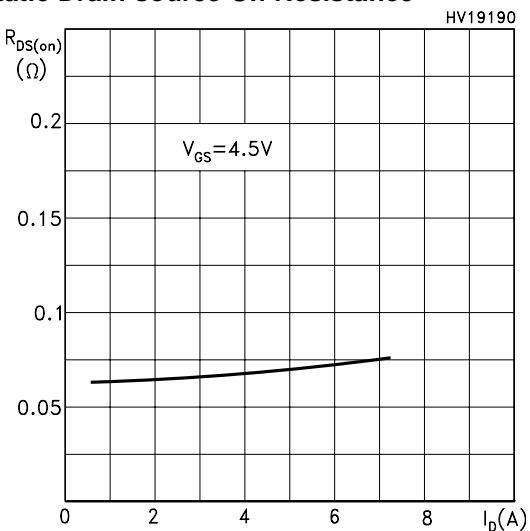
Transfer Characteristics

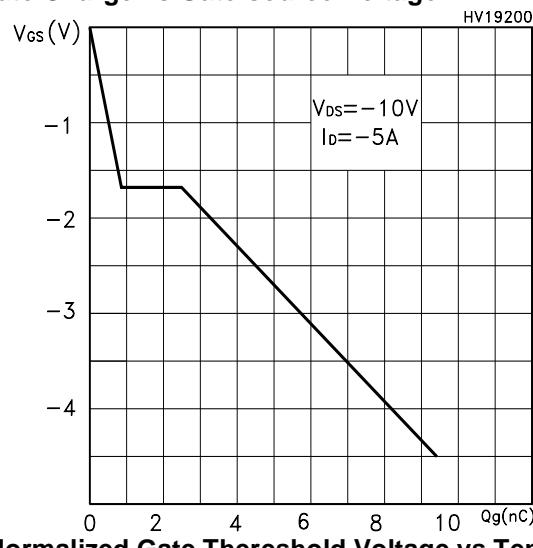
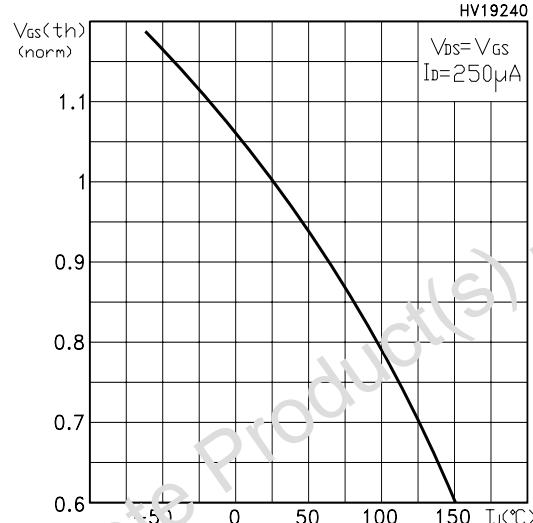
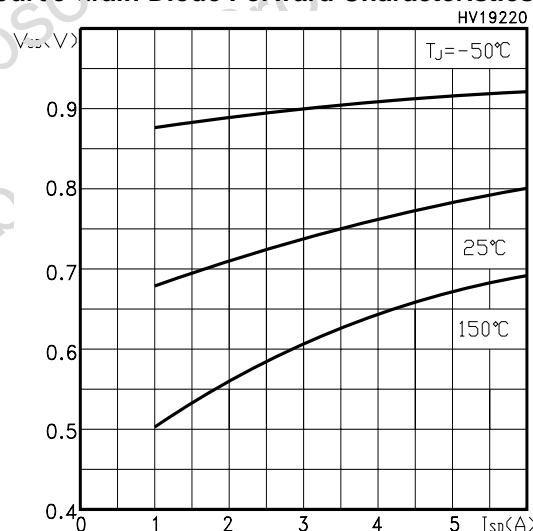
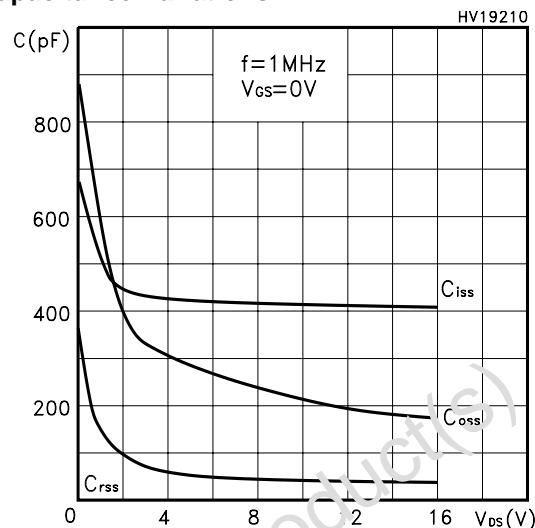
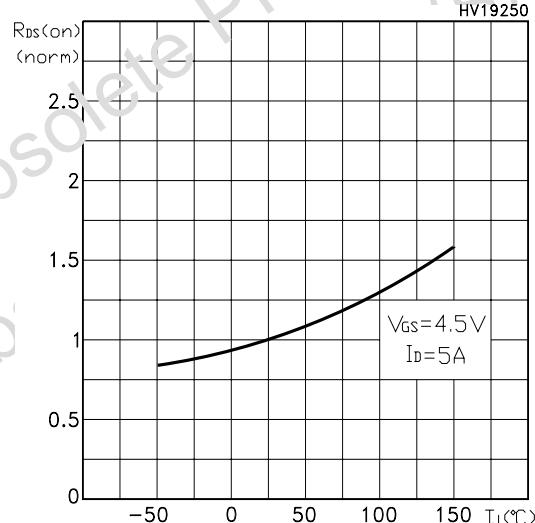


Transconductance



Static Drain-source On Resistance



Gate Charge vs Gate-source Voltage**Normalized Gate Threshold Voltage vs Temp.****Source-drain Diode Forward Characteristics****Capacitance Variations****Normalized On Resistance vs Temperature**

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Fig. 1: Switching Times Test Circuit For Resistive Load

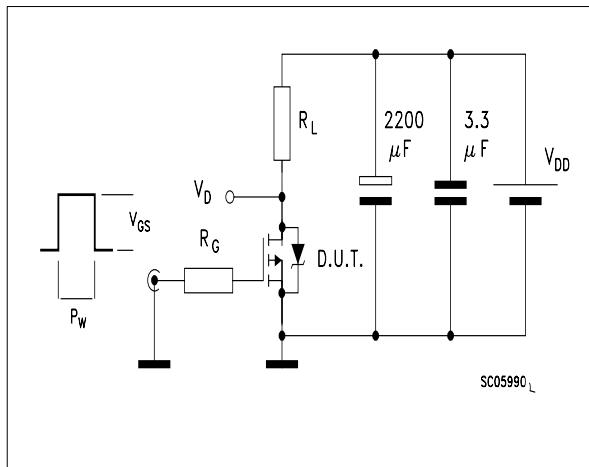


Fig. 2: Gate Charge test Circuit

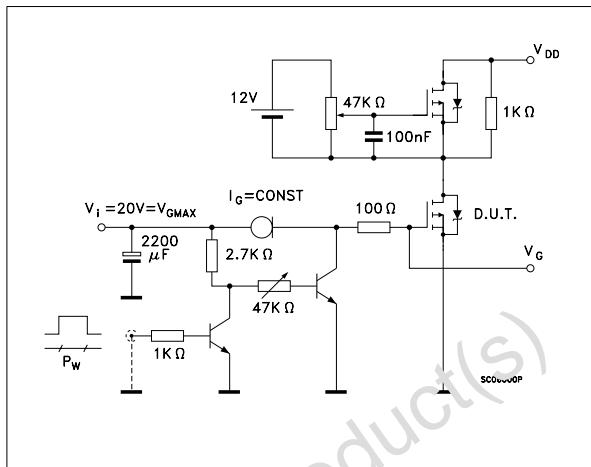
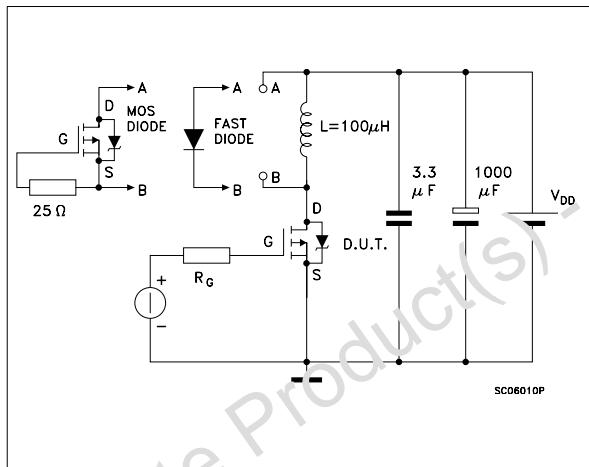
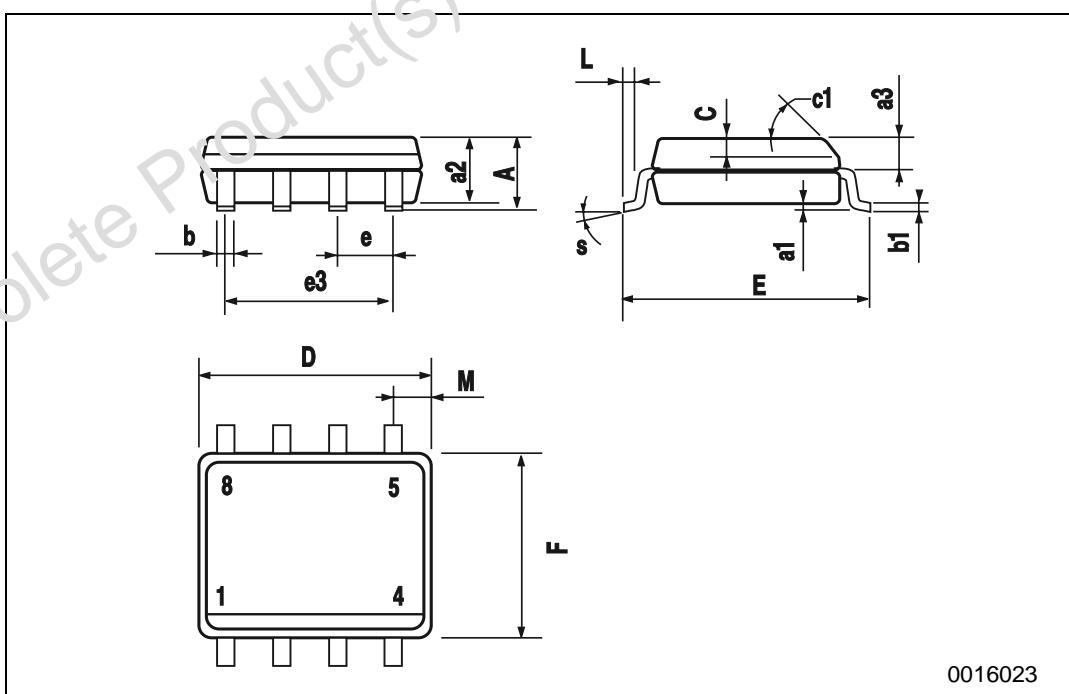


Fig. 3: Test Circuit For Diode Recovery Behaviour



SO-8 MECHANICAL DATA

| DIM. | mm | | | inch | | |
|------|------|-----------|------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | | | 1.75 | | | 0.068 |
| a1 | 0.1 | | 0.25 | 0.003 | | 0.009 |
| a2 | | | 1.65 | | | 0.064 |
| a3 | 0.65 | | 0.85 | 0.025 | | 0.033 |
| b | 0.35 | | 0.48 | 0.013 | | 0.013 |
| b1 | 0.19 | | 0.25 | 0.007 | | 0.010 |
| C | 0.25 | | 0.5 | 0.010 | | 0.019 |
| c1 | | 45 (typ.) | | | | |
| D | 4.8 | | 5.0 | 0.188 | | 0.196 |
| E | 5.8 | | 6.2 | 0.228 | | 0.244 |
| e | | 1.27 | | | 0.050 | |
| e3 | | 3.81 | | | 0.150 | |
| F | 3.8 | | 4.0 | 0.14 | | 0.157 |
| L | 0.4 | | 1.27 | 0.015 | | 0.050 |
| M | | | 0.6 | | | 0.023 |
| S | | 8 (max.) | | | | |



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